

UNISONIC TECHNOLOGIES CO., LTD

## UT3419

# 20V, 3.5A P-CHANNEL ENHANCEMENT MODE FIELD EFFECT TRANSISTOR

## DESCRIPTION

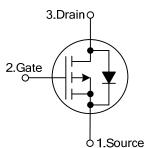
The UTC **UT3419** is a P-channel enhancement MOSFET providing designers with excellent  $R_{DS(ON)}$ , low gate charge. The gate voltage is as low as 2.5V.

The UTC **UT3419** can be applied in PWM applications or used as a load switch.

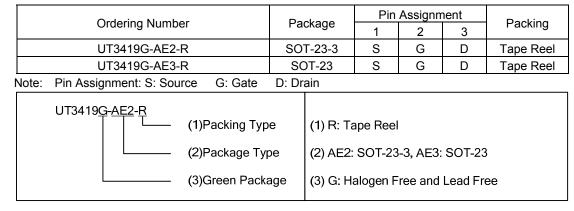
## FEATURES

 $\label{eq:RDS(ON)} \begin{array}{l} * \; R_{DS(ON)} < 75 m \Omega \; (V_{GS} = -10V) \\ R_{DS(ON)} < 95 m \Omega \; (V_{GS} = -4.5V) \\ R_{DS(ON)} < 145 m \Omega \; (V_{GS} = -2.5V) \end{array}$ 

#### SYMBOL

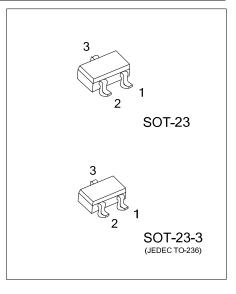


**ORDERING INFORMATION** 



#### MARKING





## **Power MOSFET**

#### ■ ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> =25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain to Source Voltage		V <sub>DSS</sub>	-20	V
Gate to Source Voltage		V <sub>GSS</sub>	±12	V
Continuous Drain Current (Note 1)	T <sub>A</sub> =25°C	I <sub>D</sub>	-3.5	А
	T <sub>A</sub> =70°C		-2.8	А
Pulsed Drain Current (Note 2)		I <sub>DM</sub>	-15	А
Total Power Dissipation (Note 1)	T <sub>A</sub> =25°C	PD	1.4	W
	T <sub>A</sub> =70°C		0.9	W
Junction Temperature		TJ	-55 ~ +150	°C
Storage Temperature		T <sub>STG</sub>	-55 ~ +150	°C

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

#### THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient (Note 1)	t ≤ 10s	θ <sub>JA</sub>	90	°C/W
	Steady-State		125	°C/W

Notes: 1. The value of  $\theta_{JA}$  is measured with the device mounted on  $1in^2$  FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^{\circ}$ C. The value in any a given application depends on the user's specific board design. The current rating is based on the t  $\leq$  10s thermal resistance rating.

2. Repetitive rating, pulse width limited by junction temperature.



PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =-250µA	-20			V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =-16V,V <sub>GS</sub> =0V			-0.5	μA
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V ,V <sub>GS</sub> =±10V			±100	nA
		V <sub>DS</sub> =0V ,V <sub>GS</sub> =±12V			±100	nA
ON CHARACTERISTICS		_				
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , Ι <sub>D</sub> =-250μΑ	-0.7	-0.9	-1.4	V
On State Drain Current	I <sub>D(ON)</sub>	V <sub>GS</sub> =-4.5V, V <sub>DS</sub> =-5V	-15			А
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-10V,I <sub>D</sub> =-3.5A		59	75	mΩ
		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-3A		76	95	mΩ
		V <sub>GS</sub> =-2.5V, I <sub>D</sub> =-1A		111	145	mΩ
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =-5V, I <sub>D</sub> =-3.5A		6.8		S
DYNAMIC PARAMETERS		_				
Input Capacitance	CISS			512	620	pF
Output Capacitance	Coss	V <sub>DS</sub> =-10V,V <sub>GS</sub> =0V, f =1MHz		77		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>			62		pF
Gate Resistance	R <sub>G</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f =1MHz		9.2	13	Ω
SWITCHING PARAMETERS						
Total Gate Charge	$Q_{G}$			5.5	6.6	nC
Gate-Source Charge	Q <sub>GS</sub>	V <sub>DS</sub> =-10V,V <sub>GS</sub> =-4.5V,		0.8		nC
Gate-Drain Charge	Q <sub>GD</sub>	I <sub>D</sub> =-3.5A		1.9		nC
Turn-ON Delay Time	t <sub>D(ON)</sub>			5		ns
Turn-ON Rise Time	t <sub>R</sub>	V <sub>DS</sub> =-10V,V <sub>GS</sub> =-10V,		6.7		ns
Turn-OFF Delay Time	t <sub>D(OFF)</sub>	R <sub>L</sub> =2.8Ω, R <sub>GEN</sub> =3Ω		28		ns
Turn-OFF Fall Time	t⊧			13.5		ns
SOURCE- DRAIN DIODE RATINGS A	ND CHAR	ACTERISTICS				
Drain-Source Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =-1A, V <sub>GS</sub> =0V	-0.65	-0.81	-0.95	V
Maximum Body-Diode Continuous	Is				-2	А
Body Diode Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> =-3.5A, dl/dt=100A/µs		9.8	12	ns
Body Diode Reverse Recovery Charge		I <sub>F</sub> =-3.5A, dI/dt=100A/µs		2.7		nC
			-			

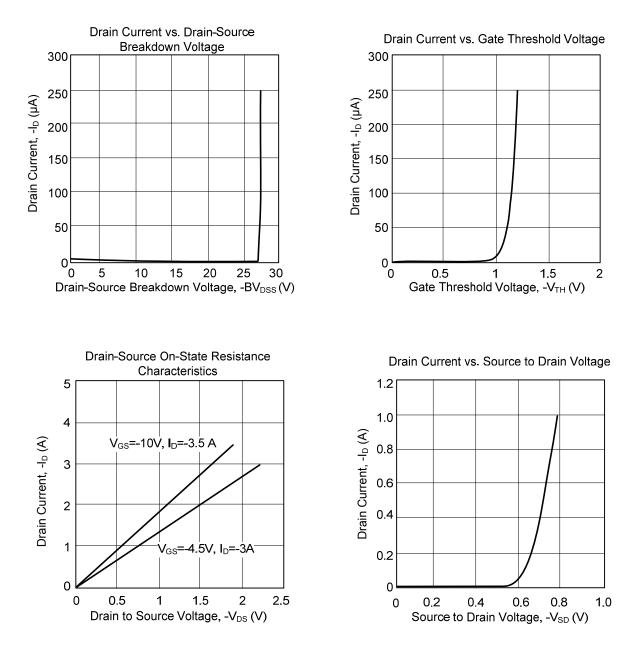
### ■ ELECTRICAL CHARACTERISTICS (T<sub>J</sub> =25°C, unless otherwise specified)

Notes: 1. The  $\theta_{JA}$  is the sum of the thermal impedance from junction to lead  $\theta_{JL}$  and lead to ambient.

2. These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^{\circ}$ C. The SOA curve provides a single pulse rating.



## TYPICAL CHARACTERISTICS



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